Declaration, Petition and Power of Attorney for Patent Application

As a below named inventor, I hereby declare that:

My residence, mailing address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHOD OF MANUFACTURING INTERCONNECTION LINE IN SEMICONDUCTOR DEVICE

the specificat	ion of which (check only one):
<u>X</u>	is attached hereto; or
	was filed as United States or PCT International Application Serial No on and was amended on (if applicable).
I hereby state	that I have reviewed and understand the contents of the specification, including the claims as amende

I hereby state that I have reviewed and understand the contents of the specification, including the claims as amended by any amendment referred to herein.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37 C.F.R. § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or (f), or §365(b) of any foreign application(s) for patent or inventor's certificate or §365(a) of any PCT international application(s) designating at least one country discount the United States of America listed below and have also identified below any foreign application(s) for the patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) fully of which priority is claimed.

Prior foreign/PCT application(s) and priority claims under 35 U.S.C. §119(a)-(d) or §365

Country	Application Number	Filing Date (day, month, year)
Korea	2001-25573	May 10, 2001

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below.

Prior U.S. applications for benefit under 35 U.S.C. §119(e)

Filing Date	

I hereby claim the benefit under 35 U.S.C.§ 120 of any United States application(s) or PCT international

application(s) designating the United States of America that is/are listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose material information as defined in 37 C.F.R. § 1.56 which occurred between the filing date of the prior applications and the national or PCT international filing date of this application:

Prior U.S. Applications or PCT International Applications designating the U.S. for benefit under 35 U.S.C. § 120

Application Number	Filing Date (day, month, year)	Status (issued, pending, abandoned)

As a named inventor, I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Steven M. Mills Reg. No. 36,610

Anthony P. Onello, Jr. Reg. No. 38,572

Send correspondence and direct telephone calls to:

Steven M. Mills MILLS & ONELLO LLP Eleven Beacon Street, Suite 605 Boston, Massachusetts 02108 phone: (617) 994-4900 facsimile: (617) 742-7774

Wherefore I petition that letters patent be granted to me for the invention or discovery described and claimed in the attached specification and claims and to the foregoing declaration, power of attorney, and this petition.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willfulf alies statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willfulf alies statements may jeopardize the validity of the application or any patent issued thereon.

First	Inventor

Family Name Lee	First Given Name Soo-geun	Second Given Name
City of Residence Suwon-city, Kyungki-do	State or Foreign Country of Residence Republic of Korea	Country of Citizenship Republic of Korea
Post Office Address 117-1602, Byucksan Apt., Mangpo-dong, Paldal-gu	Suwon-city, Kyungki-do	State & Zip Codo/Country Republic of Korea
Signature Lee Soo-Heun		Date ob, February, 2002

ist.
210) 2001
Ç.)
C
343,
(1)
0
E de
E
100
Fig.
T.
Cal
Fi i

Second Inventor		
Family Name Shin	First Given Name Hong-jae	Second Given Name
City of Residence Seoul	State or Foreign Country of Residence Republic of Korea City Seoul	Country of Catzenship Republic of Korea State & Zip Cote/County Republic of Korea
Post Office Address 103-1001, Woobang Apt., 1715, Sinlim4-dong, Kwanak-gu		
Signature Shim	Hong-Jae	Date 12, February, 2002

Third Inventor

Family Name Lee	First Given Name Kyoung-woo	Second Given Name
City of Residence Seoul	State or Foreign Country of Residence Republic of Korea	Country of Crizenship Republic of Korea
Post Office Address 102-202, Samsung Apt., Singil4- dong, Youngdeungpo-gu	City Seoul	State & Zip Code/Country Republic of Korea
Signature Lee Kyonng-Woo		Date of . February 2002

Fourth Inventor		
Family Name Kim	First Given Name	Second Green Name
Killi	Jae-hak	
City of Residence	State or Foreign Country of Residence	Country of Catazenshap
Seoul	Republic of Korea	Republic of Korea
Post Office Address	City	State & Zip Code/Country
1207, Hyundai Apt., 62-5,	Seoul	Republic of Korea
Munjeong-dong, Songpa-gu		
Signature Kim Jae-hak		Date .
Rim Jae-no	N.	06. February, 2002

J:\SAM\0313\decpoa.wpd